A3255-Q48 SHA256 Processor Datasheet

Version 0.3

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1. GENERAL DESCRIPTION

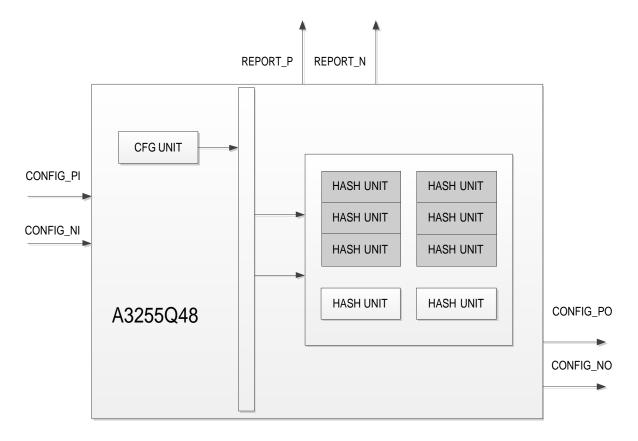
A3255Q48 is the second generation SHA256 Processor designed by AVALON team, comes with higher hash speed and performance per watt. The major applications for this chip is provide a chip level solution for SH256 related work.

Key Feature

- 128 hash units inside
- 1G Hash Rate guaranteed when core voltage is 0.9V overclocking available.
- typical power consumption is 2.05Ws/GHash
- communication protocol compatible with A3256Q48
- support chain-mode, drastically reduced controller I/O port requirement
- configurable clock frequency

2. SYSTEM ARCHITECTURE

Figure 2-1 Chip Architecture



3. DATA INTERFACE

3.1 Communication Protocol

A3255Q48 uses a two-wire asynchronous serial communication protocol. Two wires, DATA_P and DATA_N carry information from transmitter to receiver. The two-wire bus has 3 states, IDLE, SENDO and SEND1. Every transaction start with IDLE and when it finish, it should back to IDLE.

Figure 3-1 IDLE state

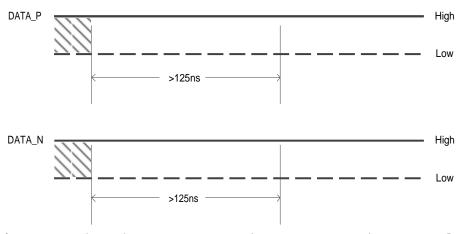


Figure 3-1 shows bus IDLE state. When DATA_P=1 and DATA_N=1 last over 125ns, bus enter into IDLE state, every transaction must start and end with IDLE state

Figure 3-2 SEND0 state

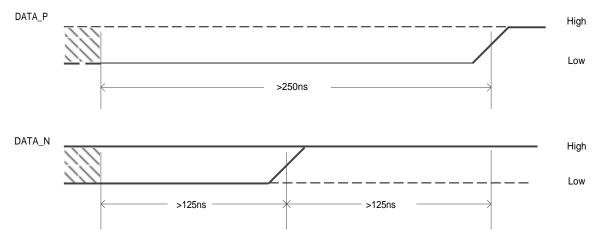


Figure 3-2 shows bus SEND0 state. SEND0 could send one bit 0 to bus. SEND0 state starts with DATA_P=0 and DATA_N=0, after 125ns, DATA_P stays low and DATA_N transform from low to high and lasts over 125ns, then if no more bit to transfer DATA_P and DATA_N return to high, and bus is back to IDLE state.

Figure 3-3 SEND1 state

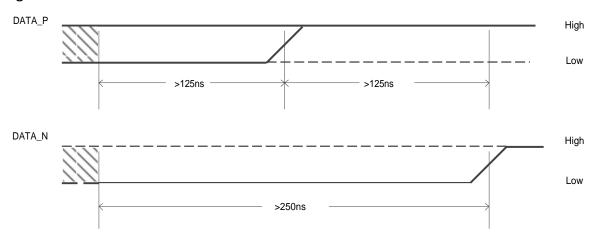


Figure 3-3 shows bus SEND1 state. SEND1 could send one bit 1 to bus. SEND1 state starts with DATA_P=0 and DATA_N=0, after 125ns, DATA_N stays low and DATA_P transform from low to high and lasts over 125ns, then if no more bit to transfer DATA_P and DATA_N return to high, and bus is back to IDLE state.

Figure 3-4 Multi-bit transfer (0Xca)

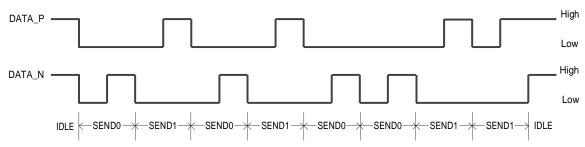


Figure 3-4 shows bus state when sending 0Xca. Bus could transfer multi-bit without IDLE state inside the transaction, multi-bit transaction start with IDLE state and then transfer data by SENDO or SEND1. When the transaction finish, it should back to IDLE state.

3.2 Communication Port

A3255Q48 uses 6 communication ports to receive configurations, transmit the configurations to the chip at next stage and send out the calculation result, details are listed in Table 3.1

Table 3.1 A3255Q48 Communication Port

PIN NAME	PROTOCOL PORT	FUNCTION
CONFIG_PI	DATA_P	receive configurations from controller or another
		A3255Q48 chip
CONFIG_NI	DATA_N	receive configurations from controller or another
		A3255Q48 chip
CONFIG_PO	DATA_P	transmit the configurations to the chip at the next
		stage

CONFIG_NO	DATA_N	transmit the configurations to the chip at the next
		stage
REPORT_P	DATA_P	send out the golden nonce when A3255Q48 get the share
REPORT_N	DATA_N	send out the golden nonce when A3255Q48 get the share

4. DATA FORMAT

Three segments should be configured before A3255Q48 hash calculation by CONFIG_PI and CONFIG_NI. Clock configuration segment is for adjusting clock frequency, gating core clock or switching clock source. Hash data segment is the initial input data of SHA256 HASH. Hash work of chips in the same chain is split by the initial nonce segment. Configure data should send as the order shown in Figure 4-1





When A3255Q48 get the nonce, it will return the nonce by REPORT_P and REPORT_N.

All input/output data is 32bit aligned, and send out in LSB(that means lowest bit send first).

4.1 Clock Configuration Segment

```
Clock configuration segment has two words (1word=32bit), detail information of each
bit listed below.
Bit[0]:Reserved, should be 1.
Bit[1]:clock configuration effect bit, if this bit is 0, all clock configuration
at current transaction is ineffective.
Bit[2]:clock frequency effect bit, set to 1 if there are clock divider changes.
Bit[3]:clock gate, hash unit working clock will be gated it set to 1.
Bit[4]:clock will divided by 2 if set to 1
bit[5]:clock switch, hash unit working clock will switch to XCLKIN if set to 1.
Bit[6]:enable/disable core clock output to PAD, when set to 1, core clock
output to PAD CORE CLOCKOUT is disabled.
Bit[15:7]:Reserved, should be 0x00000
bit[20:16] clock input divider R
bit[27:21] clock feedback divider F
bit[29:28] clock output divider OD
hash unit working clock frequency = XCLKIN frequency * F/(R*(2^{OD})).
F, R and OD configuration should satisfy the following three conditions:
   10MHz <= XCLKIN/R <= 50MHz
   500MHz <= XCLKIN*F/R <= 1000MHz
   62.5MHz \leftarrow XCLKIN*F/(R*(2^OD)) \leftarrow 1000MHz
bit[63:30]:Reserved, should be 0x0.
```

4.2 HASH Data Segment

To reduce cost and get higher speed, A3255Q48 put some pre-calculation out of the chip. Controller need to do this calculation and send the result to A3255Q48. Part of code is list below in pseudo code:

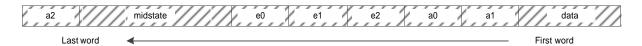
```
void functionpre_calc
for(i=0;i<64;i++)
{
    t1=h+E1(e)+CH(e,f,g)+K[i]+w[i];
    t2=E0(a)+MAJ(a,b,c);
h=g; g=f;</pre>
```

```
f=e;
    e=d+t1;
    d=c; c=b;
    b=a;
    a=t1+t2;
    if(i=0) a0 = a;
    if(i=1) a1 = a;
    if(i=2) a2 = a;
    if(i=0) e0 = e;
    if(i=1) e1 = e;
    if(i=2) e2 = e;
}
```

a0, a1, a2, e0, e1, e2 is the pre-calculation result should send to A3255Q48 (for further information, please refer to $\frac{\text{http://en.wikipedia.org/wiki/SHA256}}{\text{http://en.wikipedia.org/wiki/SHA256}}$).

The complete sequence of Hash Data Segment is shown in Figure 4-2

Figure 4-2 Hash Data Segment Transfer Sequence



All data is sent in LSB, means low bit, low byte and low word is sent first

4.3 Initial Nonce Segment

Since A3255Q48 could work in chain mode, and different chips in the same chain receive the same HASH data, so initial nonce value is the only different that could

split the work. The length of this segment is N word, N is the chain length. After initial nonce value configuration, all A3255Q48 chips get their own initial nonce, and then they could work at different range. For an example, if 10 chips are in the same chain, the nonce range segment should be 10 word long, and the whole 2^32 nonce should be split to 10 different areas, the configuration is shown in Figure 4-3.

Figure 4-3 Initial Nonce Configuration Example (10 chips)

1111111111111111111	111111111111	(1111111111111	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,
0x00000000 0x19999999 0x33333332	0x4cccccb 0x66666664	0x7fffffd 0x99999996	0xb333332f 0xcccccc8 0xe6666661
11111/1111/11/11	1,,,,,,,,,,,,	111111111111	

As shown in figure 4-3, the 10 chips start to do hash calculation with their configured initial nonce after configuration.

4.4 Receive Nonce

A3255Q48 will send out the nonce value only when it get shares. The REAL golden nonce and the received nonce satisfy the following equals:

Golden nonce = Received nonce - 0x180

Only 32 bit nonce will be sent out, so that controller should save the whole hash data and match the result to work received

5. PIN ASSIGNMENTS

Signal Type	Description
Р	Power/Ground
I	Input
0	Output
PU	Internal pull-up
	resistor
PD	Internal pull-down
	resistor
/	Multi-function
	separator

5.1 System Control

PIN NO.	NO. PAD NAME TYPE		FUNCTION			
44	RSTN	I,PD	Hardware Reset signal, low voltage active.			

PIN NO.	PAD NAME	ТҮРЕ	FUNCTION
9	XCLKIN	I	Crystal Clock input to chip
43	CORE_CLKOUT	0	Debug Clock output from chip

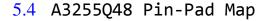
5.2 Function

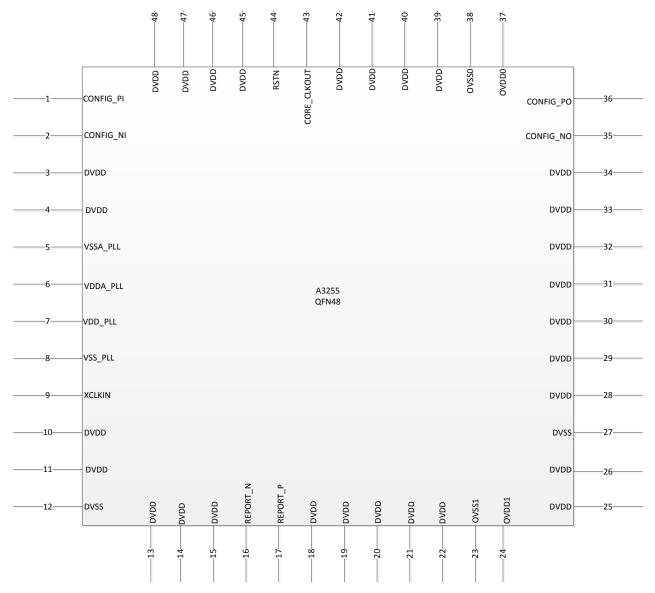
PIN NO.	PAD NAME	ТҮРЕ	FUNCTION
1	CONFIG_PI	I	Config Data input to chip
2	CONFIG_NI	I	Config Data input to chip
36	CONFIG_PO	0	Config Data output from chip
35	CONFIG_NO	0	Config Data output from chip
16	REPORT_N	O,PU	Hash Data output from chip, need pull up on PCB
17	REPORT_P	O,PU	Hash Data output from chip, need pull up on PCB

5.3 Power Supply

PIN NO.	PAD NAME	ТҮРЕ	FUNCTION			
38	0VSS0	Р	3.3V	3.3V IOO Ground		
37	OVDD0	Р	3.3V	IOO Power		
23	0VSS1	Р	3.3V	IO1 Ground		
24	OVDD1	Р	3.3V	IO1 Power		
3	DVDD	Р	0.9V	Digital Power		
4	DVDD	Р	0.9V	Digital Power		
10	DVDD	Р	0.9V	Digital Power		
11	DVDD	Р	0.9V	Digital Power		
13	DVDD	Р	0.9V	Digital Power		
14	DVDD	Р	0.9V	Digital Power		
15	DVDD	Р	0.9V	Digital Power		
18	DVDD	Р	0.9V	Digital Power		
19	DVDD	Р	0.9V	Digital Power		
20	DVDD	Р	0.9V	Digital Power		
21	DVDD	Р	0.9V	Digital Power		
22	DVDD	Р	0.9V	Digital Power		
25	DVDD	Р	0.9V	Digital Power		
26	DVDD	Р	0.9V	Digital Power		
28	DVDD	Р	0.9V	Digital Power		
29	DVDD	Р	0.9V	Digital Power		
30	DVDD	Р	0.9V	Digital Power		
31	DVDD	Р	0.9V	Digital Power		
32	DVDD	Р	0.9V	Digital Power		
33	DVDD	Р	0.9V	Digital Power		

PIN NO.	PAD NAME	ТҮРЕ	FUNCTION
34	DVDD	Р	0.9V
39	DVDD	Р	0.9V
40	DVDD	Р	0.9V
41	DVDD	Р	0.9V
42	DVDD	Р	0.9V
45	DVDD	Р	0.9V
46	DVDD	Р	0.9V
47	DVDD	Р	0.9V
48	DVDD	Р	0.9V
12	DVSS	Р	0.9V Digital Ground
27	DVSS	Р	0.9V Digital Ground
7	VDD_PLL	Р	1.0V PLL Digital Power
8	VSS_PLL	Р	1.0V PLL Digital Ground
6	VDDA_PLL	Р	1.0V PLL Ground
5	VSSA_PLL	Р	1.0V PLL Power





6. ELECTRICAL CHARACTERISTICS

6.1 Recommended Operating Conditions

The recommended operating conditions are the recommended values to assure normal logic operation. As long as the device is used within the recommended operating conditions, the electrical characteristics (DC and AC characteristics) described below are assured.

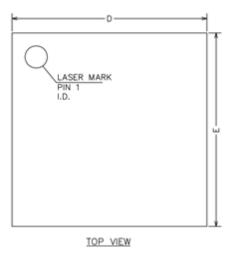
PARAMETER.	SYMBOL	MIN	ТҮР	MAX	UNIT
Supply Core voltage	DVDD	0.9	1.0	1.1	V
Supply 1.0V analog voltage	VDDA_PLL	0.9	1.0	1.1	V
Supply I/O voltage	OVDD	3.0	3.3	3.6	V
Maximum input voltage	V _{i max}			3.6	V
Operating Temperature	T _{OPR}	-20		+85	°C
Storage Temperature	T _{STOR}	-40		+150	°C
Operating Current	\mathtt{I}_OP			2000	mA
Static Current	I _{SUSP}			20	mA

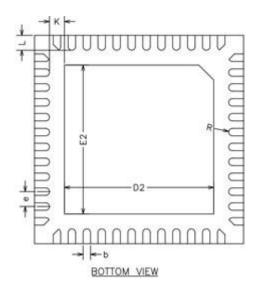
6.2 Oscillation

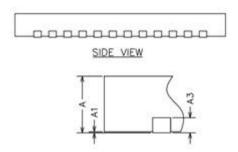
PARAMETER.	CONDI TIONS	SYMBOL	MIN	ТҮР	MAX	UNIT
Input clock frequency		Fclixin		25	1	MHz
Input clock period		Tclkxin		40		Ns
Clock duty cycle			45	50	55	%
Input pad capacitance				3.398		Pf
Jitter		-			10	Ps
Input HIGH leakage current					±10	uA
Input LOW leakage current					±10	uA

7. PACKAGE INFORMATION

7.1 A3255Q48 Package Specifications







COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX
Α	0.70	0.75	0.80
A1	0	0.02	0.05
A3	0.20REF		
b	0.18	0.25	0.30
D	6.90	7.00	7.10
E	6.90	7.00	7.10
D2	4.50	4.65	4.80
E2	4.50	4.65	4.80
е	0.40	0.50	0.60
K	0.20	_	
L	0.45	0.50	0.55
R	0.09	ı	ı

8. REVISION HISTORY

Version No.	Remarks	Release Date
0.1	Initial version released for engineering review.	2013-09-03
0.2	Fix clock configuration descriptions	2013-09-10
0.3	To do	2013-09-29